

Docket No.: 067162-0021



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277
Ryu MAKABE, et al. : Confirmation Number: 4281
Application No.: 10/662,276 : Group Art Unit: 2813
Filed: September 16, 2003 : Examiner: Tuan H. Nguyen

For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP AND DICING METHOD OF A SEMICONDUCTOR WAFER

PETITION FOR EXTENSION OF TIME

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

It is respectfully requested that the time for response to the Office Action dated April 5, 2005, now due to expire July 5, 2005, be extended for two month(s) and set to expire on September 5, 2005.

Please charge the extension fee of \$450.00 to Deposit Account No. 500417. Please charge any additional fees or credit any overpayment to Deposit Account No. 500417.

Respectfully submitted,

08/31/2005 SDENB081 00000060 500417 10662276
01 FC:1252 450.00 DA

McDERMOTT WILL & EMERY LLP

A handwritten signature in cursive script that reads "Gene Z. Robinson".

Gene Z. Robinson
Registration No. 33,351

600 13th Street, N.W.
Washington, DC 20005-3096
Phone: 202.756.8000 GZR:lnm
Facsimile: 202.756.8087
Date: August 29, 2005
WDC99 1126513-1.067162.0021

**Please recognize our Customer No. 20277
as our correspondence address.**